SSD1963 3.5"



This datasheet gives detailed information about the Riverdi 3.5" SSD1963 displays with an SPI interface. The displays come in different versions: with **capacitive, resistive, or no touchscreen**, as well as with our without a **metal mounting frame**.

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Rev.1.0 2019-06-07

ITEM	CONTENTS	UNIT
LCD Type	TFT/Transmissive/Normally white	/
Size	3.5	Inch
Viewing Direction	12:00 (without image inversion)	O' Clock
Gray Scale Inversion Direction	6:00	O' Clock

Number of Dots		320 x (RGB) × 240	/
Driver IC		SSD1963	/
Interface Type		Parallel 8/16b (i80 by default) – SPI	/
no touch module		540	
Brightness	CTP module	480	cd/m2
	RTP module	540	
Color Depth		262k	/
Pixel Arrangement		RGB Vertical Stripe	/
Surface Treatment		Anti-glare / Clear (for CTP)	/
Input Voltage		3.3	V

Note 1: RoHS, REACH SVHC compliant

Note 2: LCM weight tolerance: ± 5%.

Revision Record

REV NO.	REVDATE	CONTENTS	REMARKS
1.0	2019-06-07	Initial Release	

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11.1. Inspection condition

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1. Module classification information

RV	Т	3.5	Α	320 240	С	x	W	X	36
1.	2.	3.	4.	5.	6.	7.	8.	9.	10.

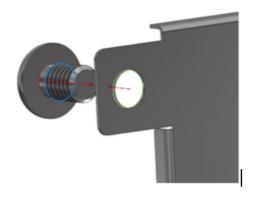
1.	BRAND	RV – Riverdi	
2.	PRODUCT TYPE	T – TFT Standard	
3.	DISPLAY SIZE	35 – 3.5"	
4.	MODEL SERIAL NO.	A (A-Z)	
5.	RESOLUTION	320240- 320×240 px	
6.	INTERFACE	C – TFT+controller	
		N – No Frame	
7.	FRAME	F – Mounting Frame	
8.	BACKLIGHT TYPE	W – LED White	
		N – No Touch Panel	
9.	TOUCH PANEL	R – Resistive Touch Panel C – Capacitive Touch Panel	
10.	VERSION	36 (00-99)	

2. Mounting frame

For dimensions 3.5", 4.3", 5.0" and 7.0" the product with mounting frame version is available. Thanks to the four catches attached to the side, frame provides strong assembly to the surface by mounting element (like the screw, see Figure 3). The frames are specially designed to fit Riverdi products perfectly. The diameter of the mounting hole is 3.5mm.

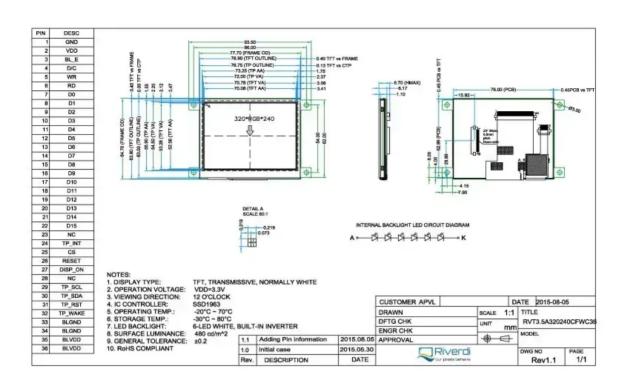
Figure 1. Mounting frame

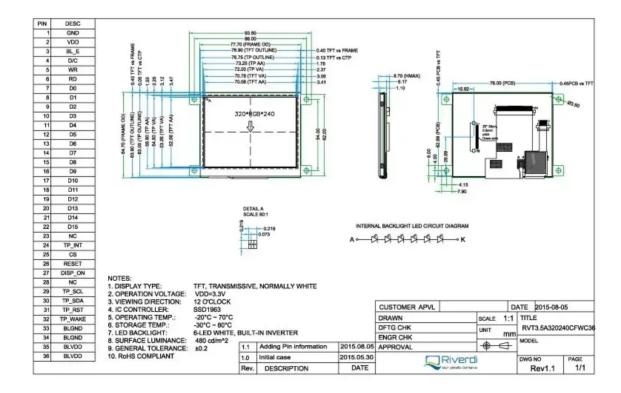


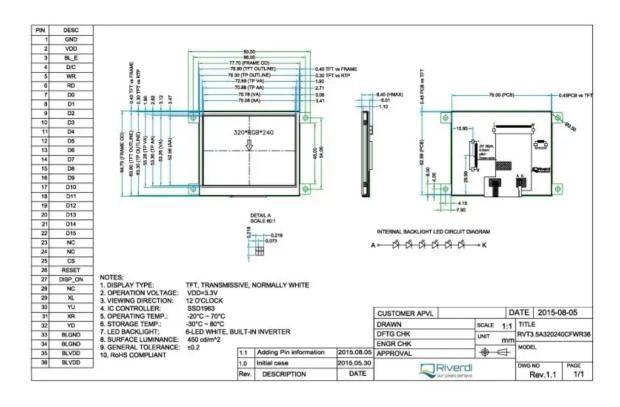


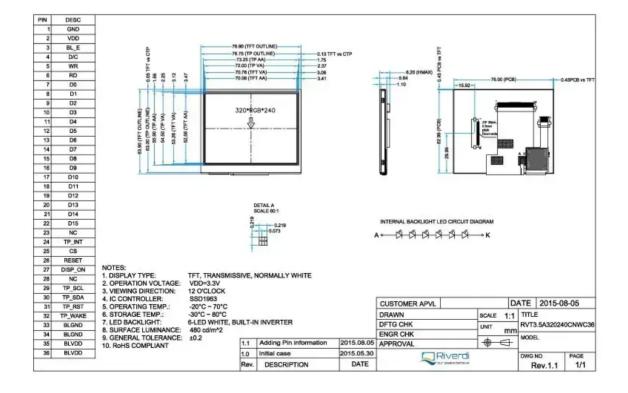
PART NUMBER	DESCRIPTION
RVT3.5A320240CNWN36	SSD1963
RVT3.5A320240CNWR36	SSD1963, RTP
RVT3.5A320240CNWC36	SSD1963, CTP
RVT3.5A320240CFWN36	SSD1963, Frame
RVT3.5A320240CFWR36	SSD1963, Frame, RTP
RVT3.5A320240CFWC36	SSD1963, Frame, CTP

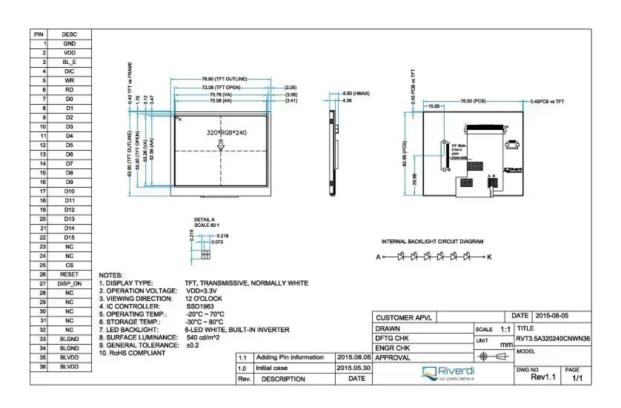
3. Drawings

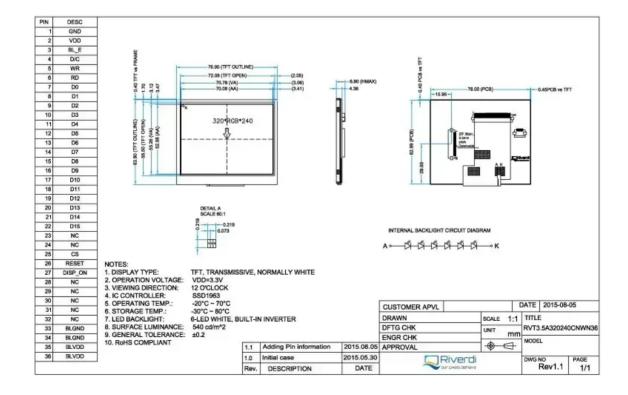












4. Absolute maximum ratings

PARAMETER	SYMBOL	MIN	MAX	UNIT
Supply Voltage for Logic	V _{DD}	-0.3	4.6	V
Input Voltage for Logic	V _{IN}	-0.3	VDD	V
Input voltage for LED inverter	BLVDD	-0.3	7.0	V
Operating Temperature	T _{OP}	-20	70	°C
Storage Temperature	T _{ST}	-30	80	°C
Humidity	RH	_	90% (Max 60°C)	RH

5. Electrical characteristics

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	NOTES
Supply Voltage For Module	VDD	3.0	3.3	3.6	V	
Input Voltage for LED Inverter	BLVDD	2.8	3.3	5.5	V	
Input Voltage 'H' level for BL_E pin	BL_Eh	1.5	_	5.5	V	
Input Voltage 'L' level for BL_E pin	BL_EI	0	_	0.7	V	
Input current (exclude LED backlight)	IDD	_	31	39	mA	VDD=3.3V
LED backlight current	IDDbacklight	_	150	187	mA	BLDD=3.3v
LED backlight current	IDDbacklight	_	95	119	mA	BLDD=5v
Total Input Current (Include LED backlight 100%)	IDDtotal	_	181	226	mA	BLVDD=3.3V
Input Voltage 'H' level	Vih	0.7VDD	_	VDD	V	
Input Voltage 'L' level	Vil	0	_	0.2VDD	V	
LED Life Time	_	40000	50000	_	Hrs	Notel

Note1: The LED life time is defined as the module brightness decrease to 50% original brightness at $Ta=25^{\circ}C$

6. Electro-optical characteristics

ITEM		SYMBOL	CONDITION	MIN	TYP	MAX	UNIT	REMARK	NOTE	
Response Time		Tr+Tf		_	25	30	ms	Figure 1	4	
Contrast Rati	Contrast Ratio		0-00	_	350	-	_	Figure 2	1	
Luminance L	Iniformity	δ WHITE	θ=0°	75	80	-	%	Figure 2	3	
Surface	TFT			-	540	_				
Luminance	TFT+CTP	Lv	Ta=25°C -	_	480	-	cd/m2	Figure 2	2	
Larrinarice	TFT+RTP			-	450	-				
	·		Ø = 90°	30	40	_	deg	Figure 3		
Violving Ang	Viscosios en Austria Decembra	θ	Ø = 270°	50	60	-	deg	Figure 3	6	
Viewing Angle Range		U	Ø = 0°	50	60	-	deg	Figure 3		
			Ø = 180°	50	60	-	deg	Figure 3		
	Red	X		0.574	0.624	0.674	Figure 2			
	Red	У		0.318	0.368	0.418			5	
	Croon	Х		0.3	0.35	0.4				
CIE (x, y)	Green	У	θ=0°	0.5	0.55	0.6				
Chromaticity	Blue	Х	Ø-0 Ta=25°C	0.093	0.143	0.193				
	blue	У	1a-25 C	0.069	0.119	0.169				
	White	X		0.26	0.31	0.36				
	vviille	У		0.283	0.333	0.383				
NTSC	-	_	_	_	50	-	%		_	

Note 1. Contrast Ratio(CR) is defined mathematically as below, for more information see Figure 3.

 $Contrast \ Ratio \ = \ \frac{Average \ Surface \ Luminance \ with \ all \ white \ pixels \ (P1, P2, P3, P4, P5)}{Average \ Surface \ Luminance \ with \ all \ black \ pixels \ (P1, P2, P3, P4, P5)}$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information, see Figure 3.

Lv = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Note 3. The uniformity in surface luminance δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information, see Figure 3.

$\delta \text{ WHITE } = \frac{\text{Minimum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Maximum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}$

Note 4. Response time is the time required for the display to transition from white to black (Rise Time, Tr) and from black to white (Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope series.

Note 5. CIE (x, y) chromaticity, the x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see Figure 4.

Note 7. For viewing angle and response time testing, the testing data is based on Autronic-Melchers's ConoScope series. Instruments for Contrast Ratio, Surface Luminance, Luminance Uniformity, CIE the test data is based on TOPCON's BM-5 photo detector.

Note 8. For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.



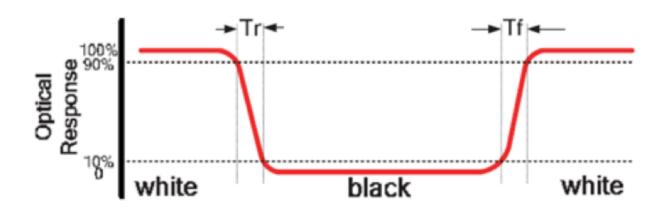


Figure 3. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

A:5 mm B:5 mm

H,V: Active Area

Light spot size Ø=5mm, 500mm distance from the

LCD surface to detector lens measurement instrument is TOPCON's luminance

meter BM-5

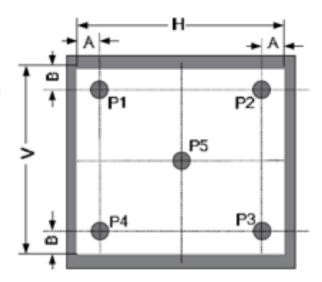
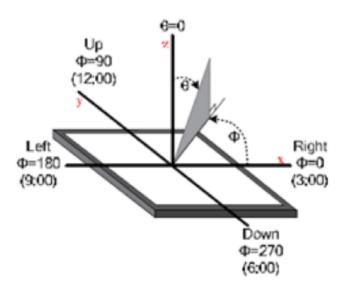


Figure 4.The definition of viewing angle



7. Interface description

PIN NO.	SYMBOL	1/0	DESCRIPTION
1	GND	Р	Power Ground
2	VDD	Р	Power Supply: +3.3V
3	BL_E	ı	Backlight Control Signal, H: On/L: Off (internally pulled-up to BLVDD)
4	D/C	1	Data/Command Select
5	WR	-	Write Strobe Signal
6	RD		Read Strobe Signal
7-22	D0-D15		Data Bus. Pins not used should be floating.

23	NC	_	No Connection
	TP_INT (CTP module)	_	Touch panel INT
24	NC (RTP module)	_	No Connection
24	NC (no touch module)	_	No Connection
25	CS	I	Chip Select
26	RESET	Ι	Hardware reset
27	DISP ON	I	Display Control H: On/L: Off (internally pulled-up)
28	NC	_	No Connection
	TP_SCL (CTP module)	_	Touch Panel I2C SCL Signal
29	XL (RTP module)	_	Touch left electrode
	NC (no touch module)	_	No Connection
	TP_SDA (CTP module)	_	Touch Panel I2C SDA Signal
30	YU (RTP module)	_	Touch up electrode
	NC (no touch module)	_	No Connection
	TP_RST (CTP module)	_	Touch Panel I2C RST Signal
31	XR	_	Touch right electrode
	NC (no touch module)	_	No Connection
	TP_WAKE(CTP module)	_	Touch Panel I2C WAKE Signal
32	YD	_	Touch down electrode
	NC (no touch module)	_	No Connection
33	BLGND	_	Backlight ground, can be connected to GND
34	BLGND	_	Backlight ground, can be connected to GND
35	BLVDD	_	Backlight power supply, can be connected to VDD
36	BLVDD	_	Backlight power supply, can be connected to VDD

8. Interface timing characteristics

8.1. 8080 mode

The 8080 mode MCU interface consist of CS#, D/C#, RD#, WR#, D[15:0]. This interface use WR# to define a write cycle and RD# for read cycle. If the WR# goes low when the CS# signal is low, the data or command will be latched into the system at the rising edge of WR#. Similarly, the read cycle will start when RD# goes low and end at the rising edge of RD#.

Interface	Cycle	D[17]	D[16]	D[15]	D[14]	D[13]	D[12]	D[11]	D[10]	D[9]	D[8]	D[7]	D[6]	D[5]	D[4]
16 bits	1 st			R5	R4	R3	R2	R1	G5	G4	G3	G2	G1	G0	B5
(565															

format)														
	1 st		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4
16 bits	2 nd		В7	В6	B5	B4	ВЗ	B2	B1	В0	R7	R6	R5	R4
	3 rd		G7	G6	G5	G4	G3	G2	G1	GO	B7	В6	B5	B4
12 bits	1 st						R7	R6	R5	R4	R3	R2	R1	RO
Z DILS	2 nd						G3	G2	G1	G0	B7	В6	B5	В4
9 bits	1 st									R5	R4	R3	R2	R1
19 DILS	2 nd									G2	G1	GO	B5	В4
	1 st										R7	R6	R5	R4
8 bits	2 nd										G7	G6	G5	G4
	3 rd										B7	В6	B5	В4

8.2. Parallel 8080-series Interface Timing

Figure 5. Parallel 8080-series Interface Timing Diagram (Write Cycle)

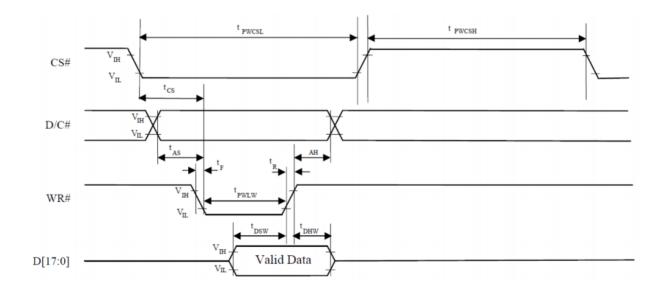
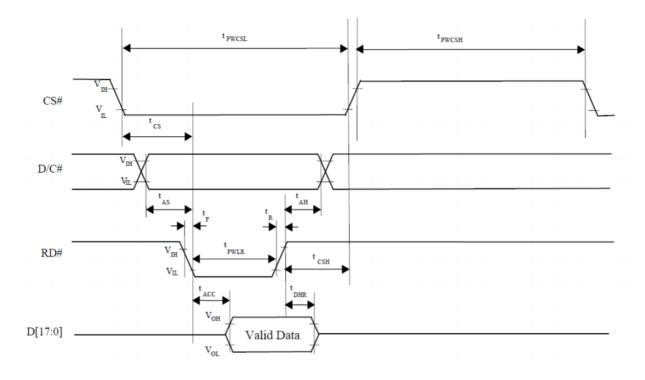


Figure 6. Parallel 8080-series Interface Timing Diagram (Read Cycle)



9. LCD timing characteristics

9.1. Timing chart

Timing parameter (VDD=3.3V, GND=0V, Ta=25°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	CONDITION
CLK Clock Time	Tclk	1/Max(FCLK)	_	1/Min(FCLK)	ns	_
CLK Pulse Duty	Tchw	40	50	60	%	TCLK
HSYNC to CLK	Thc	_	_	1	CLK	_
HSYNC Width	Thwh	1	_	_	CLK	_
VSYNC Width	Tvwh	1	_	_	ns	_
HSYNC Period Time	Th	60	63.56	67	ns	_
VSYNC Set-up Time	Tvst	12	_	_	ns	_
VSYNC Hold Time	Tvhd	12	_	_	ns	_
HSYNC Setup Time	Thst	12	_	_	ns	_
HSYNC Hold Time	Thhd	12	_	_	ns	_
Data Set-up Time	Tdsu	12	_	_	ns	D00~D23 to CLK
Data Hold Time	Tdhd	12	_	_	ns	D00~D23 to CLK
DEN Set-up Time	Tesu	12	_	_	ns	DEN to CLK

Figure 7. DE mode timing diagram

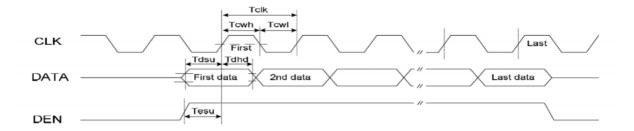


Figure 8. SYNC mode timing diagram

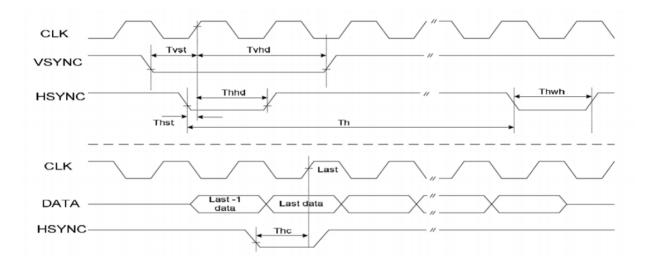
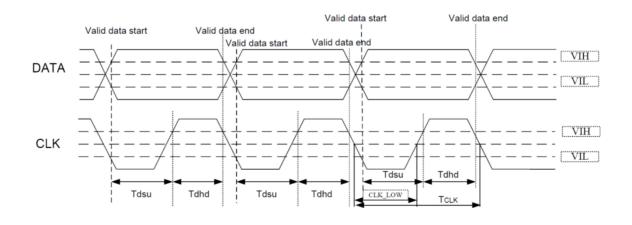


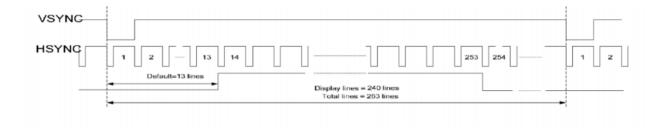
Figure 9. Timing diagram

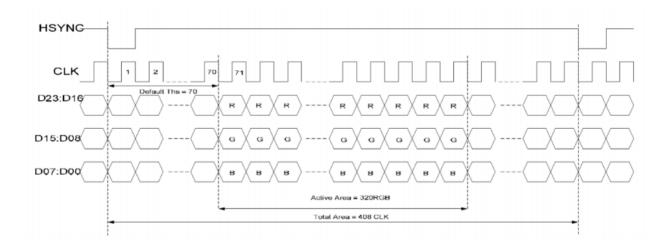


9.2. 24Bit GB Mode for 320xRGBx240

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	CONDITION
CLK Frequency	Fclk	7.0	8.0	9.0	MHz	VDD=3.0V~3.6V
CLK Cycle Time	Tclk	143	125	1111	ns	_
CLK Pulse Duty	Tcwh	40	50	60	%	_
						DDLY=70
Time that HSYNC to 1st Data Input (NTSC)	Ths	40	70	255	CLK	Offset=0(fixed)

Figure 10. 24 bit RGB SYNC mode timing





10. Touch panel specifications

10.1. Electrical characteristics

Note: Avoid operating with hard or sharp material such as a ball point pen or a mechanical pencil except a polyacetal pen (tip R0.8mm or less) or a finger

10.1.1. For capacitive touch panel

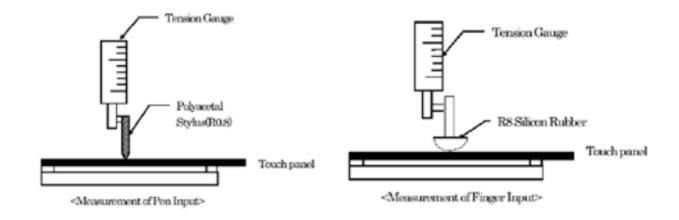
DESCRIPTION		SPECIFICATION
Operating Voltage		DC 2.8~3.6V
Power Consumption	Active Mode	10~18mA
(IDD)	Sleep Mode	30~50µA
Interface		1 ² C
Linearity		<1.5%
Controller		FT5346
I2C address		0x38 (7 bit address)
Resolution		896*640

10.1.2. For resistive touch panel

ITEM		VALUE		UNIT	REMARK
I I CIAI	Min.	Тур.	Max.	ONIT	REMARK
Linearity	-3.0	_	1.5	%	Analog X and Y directions
Terminal Resistance	200	_	900	Ω	X
Terminal Resistance	100	_	600	Ω	Υ
Insulation Resistance	20	_	_	ΜΩ	DC 25V
Voltage	_	_	10	V	DC
Chattering	_	_	10	ms	100kΩ pull-up
Transparency	78	_	_	%	JIS K7105

10.2. Mechanical characteristics

Note 1: Force test condition, Input DC 5V on X direction, Drop off Polyacetal Stylus (R0.8), until output voltage stabilize, then get the R8.0mm Silicon rubber and do finger Activation force test. Next step, 9 points.



Note 2: Measurement surface area conditions, Scratch 100,000 times straight line on the film with a stylus change every 20,000 times with Force: 250gf, Speed: 60mm/sec by R0.8 polaceteal stylus.

Note 3: Pitting test, Pit 1, 000, 000 times on the film with R0.8 silicon rubber with Force: 250gf and Speed: 2 times/sec.

10.2.1 for capacitive touch panel

DESCRIPTION	INL SPECIFICATION	REMARK
Touch Panel Size	3.5 inch	
Outline Dimension (OD)	76.75 mm x 63.00mm	Cover Lens Outline
Product Thickness	1.26 mm± 0.1mm	
Glass Thickness	0.7 mm± 0.1mm	
Ink View Area	72.85mm x 55.50mm	
Sensor Active Area	73.25mm x 55.90mm	
Input Method	5 Finger	
Activation Force	Touch	
Surface Hardness	≥7H	

10.2.2. For resistive touch panel

Note 1: Force test condition, Input DC 5V on X direction, drop off Polyacetal Stylus (R0.8), until output voltage stabilize, then get the R8.0mm Silicon rubber and do finger Activation force test. Next step, 9 points.

ITEM	\	/ALUE		UNIT	REMARK
11 [14]	Min.	Тур.	Max.	ONIT	REMARK
Activation Force	20	_	_	gf	Note 1
Durability-Surface Scratching	Write 100,000	_	_	characters	Note 2
Durability-Surface Pitting	1,000,000	_	_	touches	Note 3
Surface Hardness	3	_	_	Н	JIS K5400

10.3. Capacitive touch panel parameters

10.3.1. Interface timing characteristics

PARAMETER	MIN	MAX	UNIT
SCL Frequency	0	400	kHz
Bus Free Time Between a STOP and START Condition	4.7	/	μs
Hold Time (repeated) START Condition	4.0	/	μs
Data Setup Time	250	/	ns
Setup Time for Repeated START Condition	4.7	/	μs
Setup Time for STOP Condition	4.0	/	μs

10.3.2. I2C Read/Write Interface description

		S	Slav	ve .	Ad	dr]	Dat	ta A	Add	lres	ss[2	X]					I	Dat	a []	X]					Ι	Dat	a []	X+	N-1]			
S	A	A	A	A	A	A	A	R	A	R	R	R 5	R	R	R	R	R	A	D	D	D	D	D	D	D	D	A	 D	D	D	D	D	D	D	D	A	P
	6	5	4	3	2	1	0	W		7	6	5	4	3	2	1	0		7	6	5	4	3	2	1	0		7	6	5	4	3	2	1	0		
ST.								WRI	A									A									A									A	ST
\RT								HIL	X									K									K									\approx	OP

Figure 12. Set Data Address

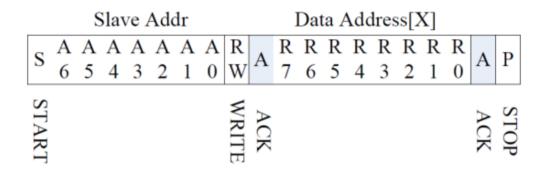
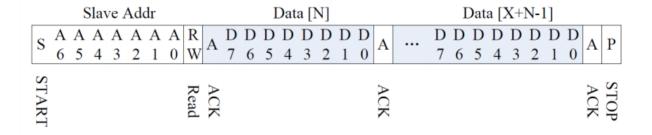
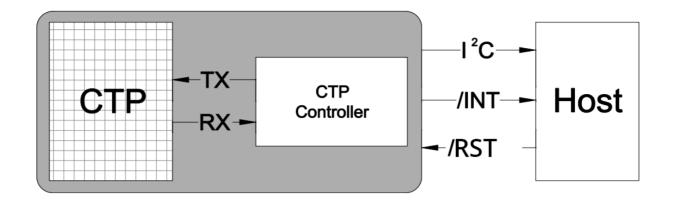


Figure 12. Read X bytes from I2C Slave



10.3.3. Communication of the I2C interface with host

Figure 13. Communication of the I2C interface with Host



10.3.4. Touch data read protocol

ADDRESS	NAME	ВІТ7	віт6	BIT5	BIT4	віт3	BIT2	віті	ВІТО	HOST ACCESS
00h	DEVIDE_MODE		Devic	e Mod	e[2:0]					RW
01h	GEST_ID	Gestu	re ID[7:	:O]						R
02h	TD_STATUS					Num point	ber of t s[3:0]	couch		R
03h	TOUCH1_XH	1st Eve Flag	ent			1st To	uch X I	Positio	n[11:8]	R
04h	TOUCH1_XL	1st To	uch X P	osition	[7:0]					R
05h	TOUCH1_YH	1st To	uch ID[3:0]		1st To	uch X I	⊃ositio	n[11:8]	R
06h	TOUCH1_YL	1st To	uch Y P	osition	[7:0]				_	R
07h										R
08h										R
09h	TOUCH2_XH	2nd E	vent				ouch X			R
0Ah	TOUCH2_XL	2nd To	ouch X	Positio	n[7:0]					R
OBh	TOUCH2_YH	2nd To	ouch IE)[3:0]			ouch X on[11:8			R
0Ch	TOUCH2_YL	2nd To	ouch Y	Positio	n[7:0]					R
0Dh										R
0Eh										R
OFh	TOUCH3_XH	3rd Ev	ent (3rd To	ouch X	Positio	on[11:8]	R
10h	TOUCH3_XL	3rd To	uch X I	Positio	n[7:0]					R
11h	TOUCH3_YH	3rd To	uch ID	[3:0]		3rd To	ouch X	Positio	on[11:8]	R
12h	TOUCH3_YL	3rd To	uch Y F	Positio	n[7:0]					R
13h										R
14h										R
15h	TOUCH4_XH	4th Ev	/ent			4th Touch X Position[11:8]				R
16h	TOUCH4_XL	4th To	ouch X	Positio	n[7:0]					R

17h	TOUCH4_YH	4th Touch ID[3:0] 4th Touch X Position[11:8]								R	
18h	TOUCH4_YL	4th To	4th Touch Y Position[7:0]								
19h										R	
1Ah										R	
1Bh	TOUCH5_XH	5th Ev	/ent			5th To	ouch X	Positio	on[11:8]	R	
1Ch	TOUCH5_XL	5th To	ouch X I	⊃ositio	n[7:0]					R	
1Dh	TOUCH5_YH	5th Touch ID[3:0] 5th Touch X Position[11:8]								R	
1Eh	TOUCH5_YL	5th Touch Y Position[7:0]								R	

10.3.5 Data description

DEVICE_MODE

This register is the device mode register, configure it to determine the current mode of the chip.

ADRESS	BIT ADRESS	REGISTER NAME	DESCRIPTION
			000b Work Mode
00h	6:4	Device Mode [2:0]	100b Factory Mode – Read Raw Data

GEST_ID

This register describes the gesture of a valid touch.

ADRESS	BIT ADRESS	REGISTER NAME	DESCRIPTION
			Gesture ID
			0x10 Move Up
			0x14 Move Down
01h	7:0	Gesture ID [7:0]	0x18 Move Right
			0x48 Zoom In
			0x49 Zoom Out
			0x00 No Gesture

TD_STATUS

This register is the Touch Data status register.

ADRESS	BIT ADRESS	REGISTER NAME	DESCRIPTION
02h	3:0	Number of Touch Points [2:0]	How Many Points Detected 1-5 is Valid
	7:4		

TOUCHn_XH(n:1-10)

This register describes MSB of the X coordinate of the nth touch point and the corresponding event flag.

ADRESS	BIT ADRESS	REGISTER NAME	DESCRIPTION
			00b: Put Down
03h			01b: Put Up
~	7:6	Event Flag	10b: Contact
39h			11b: Reserved
	5:4		Reserved
	3:0	Touch X Position [11:8]	MSB of Touch X Position in Pixels

TOUCHn_XL(n:1-10)

This register describes LSB of the X coordinate of the nth touch point.

ADRESS	BIT ADRESS	REGISTER NAME	DESCRIPTION
04h			
~	7:0	Touch X Position [7:0]	LSB of the Touch X Position in Pixels
3Ah			

TOUCHn_YH(n:1-10)

This register describes MSB of the Y coordinate of the nth touch point and corresponding touch ID.

ADRESS	BIT ADRESS	REGISTER NAME	DESCRIPTION
05h ~	7:4	Touch ID[3:0]	Touch ID of Touch Point
3Bh	3:0	Touch X Position [11:8]	MSB of Touch Y Position in Pixels

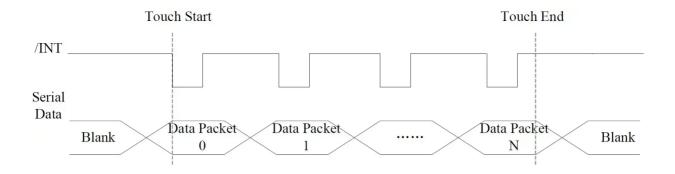
TOUCHn_YL(n:1-10)

This register describes LSB of the Y coordinate of the nth touch point.

ADRESS	BIT ADRESS	REGISTER NAME	DESCRIPTION
05h			
~	7:0	Touch X Position [7:0]	LSB of the Touch Y Position in Pixels
3Bh			

10.3.6 Interrupt Trigger Mode

Figure 14. Interrupt triger mode timing



11. Inspection

Standard acceptance/rejection criteria for TFT module.

11.1. Inspection condition

Ambient conditions:

Temperature: 25±°C

Humidity: (60±10) %RH

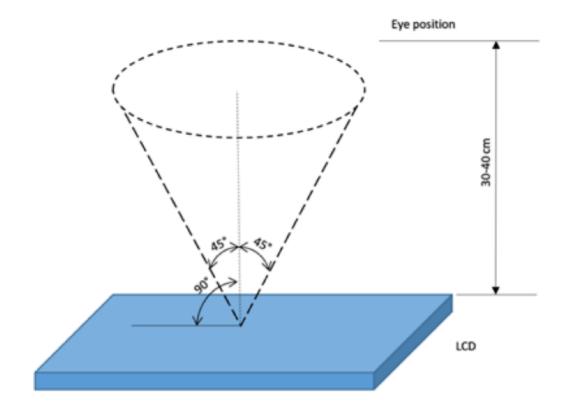
• Illumination: Single fluorescent lamp non-directive (300 to 700 lux)

Viewing distance:

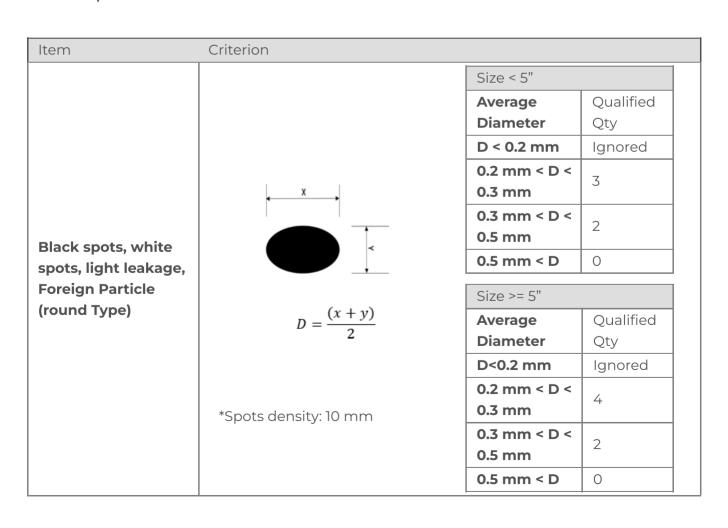
35±5cm between inspector bare eye and LCD.

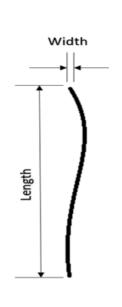
Viewing Angle:

U/D: 45°/45°, L/R 45°/45°



11.2 Inspection standard





LCD black spots,
white spots, light
leakage (line Type)

*Spots density: 10 mm

Size < 5"		
Length	Width	Qualified Qty
	\\\\\ \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	-
_	W< 0.02	Ignored
L < 3.0	0.02 < W	
	<0.05	2
L < 2.5	0.05 < W	
L \ Z.5	<0.08	
-	0.08 < W	0

Size >= 5"		
Length	Width	Qualified
Length	VVIGUI	Qty
_	W< 0.02	Ignored
L < 3.0	0.02 < W	
	<0.05	4
L < 2.5	0.05 < W	
	<0.08	
_	0.08 < W	0

Later and the second se	
Item	Criterion
ILCIII	CITCITOTI

Size < 5"	
Average Diameter	Qualified Qty
D < 0.2 mm	Ignored
0.2 mm < D < 0.3 mm	3
0.3 mm < D < 0.5 mm	2
0.5 mm < D	0

Clear spots

Size >= 5"	
Average Diameter	Qualified Qty
D<0.2 mm	Ignored
0.2 mm < D < 0.3 mm	4
0.3 mm < D < 0.5 mm	2
0.5 mm < D	0

^{*}Spots density: 10 mm

Polarizer bubbles

Size < 5"	
Average Diameter	Qualified Qty
D < 0.2 mm	Ignored
0.2 mm < D < 0.5 mm	3
0.5 mm < D < 1 mm	2
1 mm < D	0
Total Q'ty	3

Size >= 5"	
Average Diameter	Qualified Qty

	D<0.25 mm	Ignored		
	0.25 mm < D < 0.5	mm	3	
	0.5 mm < D			
	Size < 5"			
	item		Qualified Qty 4	
		Black do defect		
		Bright dot defect		
	Total Dot	al Dot		
Electrical Dot Defect	Size >= 5"			
	item		Ouglified Oty	
			Qualified Qty	
	Black do defect		5	
	Bright dot defect Total Dot		5	
	Iotal Dot		2	
Item	 Criterion			
100/11	CITETION			
	Size < 5"			
		Average Diameter		
	D < 0.2 mn			
		O < 0.4 mm	Ignored 5	
	0.4 mm < I	0.4 mm < D < 0.5 mm		
	0.5 mm < [0.5 mm < D		
Touch panel spot		0.5 mm < D		
	Size >= 5"			
	Average D	Average Diameter		
	D<0.25 mn	D<0.25 mm		
	0.25 mm <	0.25 mm < D < 0.5 mm		
	0.5 mm < [0.5 mm < D		
Touch panel White Line S				
	Size < 5"			
	Length	Width	Qualified Qty	
	-	W< 0.02	Ignored	
	L < 3.0	0.02 < W < 0.05		
	L < 2.5	0.05 < W < 0.08	2	
	_	0.08 < W	0	
		·		
	Size >= 5"	Size >= 5"		
	Length	Width	Qualified Qty	
	_	W< 0.03	Ignored	
	L < 5.0	0.03 < W < 0.05	2	
	1 1	1		

12. Reliability test

NO	TEST ITEM	TEST CONDITION	INSPECTION AFTER TEST
110.		TEST CONDITION	
1	High Temperature Storage	80±2°C/240 hours	Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:
2	Low Temperature Storage	-30±2°C/240 hours	Air bubble in the LCD Seal leak
3	High Temperature Operating	70±2°C/240 hours	3. Non-display4. Missing segments
4	Low Temperature Operating	-20±2°C/240 hours	5. Glass crack
5	Temperature Cycle	-30±2°C~25~70±2°C × 30 cycles	6. Current Idd is twice higher than initial value
6	Damp Proof Test	60°C ±5°C × 90%RH/160 hours	7. The surface shall be free from
7	Vibration Test	Frequency 10Hz~55Hz Stroke: 1.5mm Sweep: 10Hz~55Hz~10Hz 2 hours For each direction of X, Y, Z (6 hours for total)	8. Linearity must be no more than 1.5% by the linearity tester 9. The Electric characteristics requirements shall be satisfied
8	Mechanical Shock	60G 6ms, ± X, ± Y, ± Z 3 times for each direction	
9	Packing Drop Test	Height: 80 cm 1 corner, 3 edges, 6 surfaces	
10	Package Vibration Test	Random vibration: 0.015G2/Hz from 5-200Hz -6dB/Octave from 200-500Hz 2 hours for each direction of X, Y, Z (6 hours for total)	
11	Electrostatic Discharge	Air: ±8KV 150pF/330Ω 5 times Contact: ±4KV 150pF/330Ω 5 times	

		1,000,000 times in the same point	
		Hitting pad: tip R3.75mm, Silicone rubber, Hardness: 40deg.	
12	Hitting Test	Load: 2.45N	
		Hitting speed: Twice/sec	
		Electric load: none	
		Test area should be at 1.8mm inside of insulation.	
		100,000 times minimum	
		Hitting pad: tip R0.8mm plastic pen	
	Pen Sliding Durability Test	Load: 1.47N	
13		Sliding speed: 60 mm/sec	
		Electric load: none	
		Test area should be at 1.8mm inside of insulation.	
Ren	nark:		
1. Th	e test samples sho	uld be applied to only one test ite	m.
2. Sample size for each test item is 5~10pcs.			
3. Fo	or Damp Proof Test,	Pure water(Resistance	
10M	Ω) should be used.		
		n defect caused by ESD damage vould be judge as a good part.	, if it would be recovered to normal
	evaluation should ects such as	be excepted from reliability test	with humidity and temperature: Some
blac EL h		happen by natural chemical rea	ction with humidity and Fluorescence
	ailure Judgment Cr racteristic, Optical	terion: Basic Specification, Electr	ical Characteristic, Mechanical
Cha	racteristic.		

Note 1: Without water condensation.

Note 2: The function test shall be conducted after 2 hours storage at the room temperature and humidity after removed from the test chamber.



Still stuck How can we help

Updated on April 30, 2020

Was this article helpful to you



No